

Call for comments

Further to the March 2021 IEEE SA Standards Board Patent Committee (PatCom) meeting 'Review of the IEEE SA Patent Policy' agenda item, and at the direction of the IEEE SA Board of Governors (BOG), PatCom seeks public comments to be compiled and provided to the BOG regarding the Pros and Cons of the following three options:

- i. No change to the text of the 2015 Patent Policy;
- ii. Remove (a) all of the Patent Policy provisions regarding Prohibitive Orders and/or (b) the optional factors included in the definition of Reasonable Rate;
- iii. Offer more options than before by:
 - Allowing an LOA filer the ability to choose whether it may seek or not seek Prohibitive Orders in accordance with the current wording of the Patent Policy; and
 - Clarifying the optionality of the factors included in the definition of Reasonable Rate.

For each of the three options, PatCom also seeks public comments regarding the ongoing use of the Custom LOA form <<https://mentor.ieee.org/myproject/Public/mytools/mob/loa-13June2019limited-statement.pdf>>.

Responses to this Call for Comments shall be submitted by completing the spreadsheet accessible at <https://grouper.ieee.org/groups/pp-dialog/call_for_comments/PatCom_call_for_comments.xlsx> and submitting the spreadsheet to <pp-dialog@ieee.org>. Any other attachments will not be considered. All responses submitted to <pp-dialog@ieee.org> will be considered public and the comment compilation report provided to the BOG will also be made public. Please see IEEE SA Standards Board Operations Manual subclause 4.1.1.5 regarding confidentiality statements and copyright notices <<https://standards.ieee.org/about/policies/opman/sect4.html#4.1.1.5>>.

This is a call for input and is not a vote. IEEE will use its own judgment in determining what it believes is the most appropriate approach to the IEEE SA Patent Policy.

The deadline for submitting responses to this Call for Comments is **Friday, 15 October 2021 23:59 UTC-12**.

If you have questions, contact the IEEE SA Standards Board Patent Committee Administrator at <patcom@ieee.org>

Thank you for your contribution to this process.